



40V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
-40V	11mΩ @ V _{GS} = -10V	-10.1A
-40 V	15mΩ @ V _{GS} = -4.5V	-8.8A

Description & Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

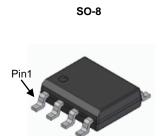
- DC-DC Converters
- Power Management Functions
- Analog Switch

Features and Benefits

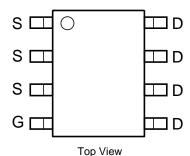
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP4015SSSQ is suitable for automotive applications requiring specific change control and is AEC-Q101 qualified, is PPAP capable, and is manufactured in IATF16949:2016 certified facilities.

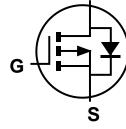
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Top View





Equivalent Circuit

Ordering Information (Note 4)

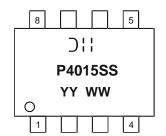
Part Number	Qualification	Case	Packaging
DMP4015SSSQ-13	Automotive	SO-8	2,500/Tape & Reel

Pin Configuration

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit			
Drain-Source Voltage	V_{DSS}	-40	V			
Gate-Source Voltage	V_{GSS}	±25	V			
Continuous Prois Correct (Note 5) V 40V	Steady	$T_A = +25^{\circ}C$		-9.1	Δ.	
Continuous Drain Current (Note 5) V _{GS} = -10V	uous Drain Current (Note 5) $V_{GS} = -10V$ State $T_A = +70^{\circ}C$		I _D	-7.2	A	
Continuous Drain Current (Note 5) V _{GS} = -4.5V	Steady	T _A = +25°C	- I _D	-7.8	Α	
Continuous Diam Current (Note 5) VGS = -4.5V	State	T _A = +70°C		-6.2		
Steady $T_A = +2$		T _A = +25°C	· I _D	-10.1	Α	
Continuous Drain Current (Note 6) V _{GS} = -10V	State $T_A = +70^{\circ}C$			-8	Α	
Continuous Drain Current (Note 6) V _{GS} = -4.5V	Steady	T _A = +25°C	I _D	-8.8	A	
Continuous Drain Current (Note 6) VGS = -4.5V	State	T _A = +70°C		-7		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-100	Α			
Avalanche Current (Note 7)	I _{AS}	-22	Α			
Avalanche Energy (Note 7)	Eas	242	mJ			

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P_{D}	1.45	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	88	°C/W
Total Power Dissipation (Note 6)	P _D	1.82	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	70	°C/W
Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	7.6	°C/W
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C

Electrical Characteristics (@ $T_A = \pm 25^{\circ}C$, unless otherwise specified.)

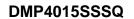
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		_	-1	μΑ	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	-1.5	-2	-2.5	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance			7	11	mΩ	$V_{GS} = -10V, I_D = -9.8A$	
Static Dialii-Source Off-Resistance	R _{DS(ON)}	_	9	15	11152	$V_{GS} = -4.5V$, $I_D = -9.8A$	
Forward Transfer Admittance	Y _{fs}		26	_	S	$V_{DS} = -20V, I_{D} = -9.8A$	
Diode Forward Voltage (Note 5)	V_{SD}		-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}		4,234	_		V _{DS} = -20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	1,036	_	pF		
Reverse Transfer Capacitance	C _{rss}		526			1 = 1101112	
Gate Resistance	R_{g}		7.77	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g		47.5		V 00V V 5V		
Gate-Source Charge	Q_{gs}		14.2	_	nC	$V_{DS} = -20V, V_{GS} = -5V$ $I_{D} = -9.8A$	
Gate-Drain Charge	Q_{gd}	_	13.5	_			
Turn-On Delay Time	t _{D(ON)}	_	13.2	_		$V_{GS} = -10V, V_{DD} = -20V, R_g = 6\Omega,$ $I_D = -1A, R_L = 20\Omega$	
Turn-On Rise Time	t _R		10	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	302.7	_	115		
Turn-Off Fall Time	t _F	_	137.9	_			

Notes:

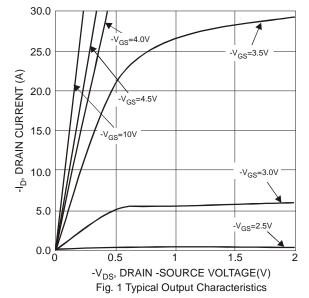
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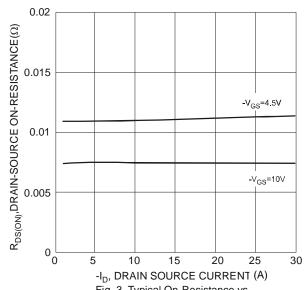
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
- 7. UIS in production with L = 1mH, $T_J = +25$ °C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

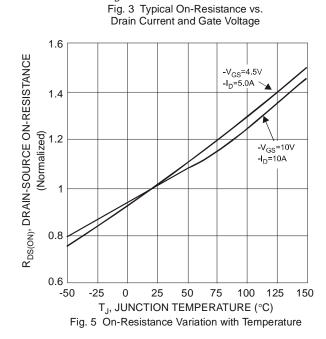
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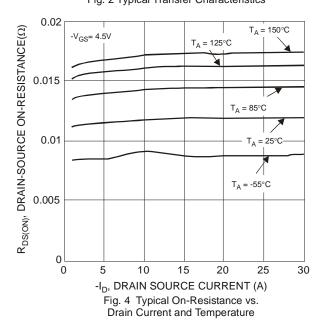








30 T_A = 150°C V_{DS}= -5.0V T_A = 25°C 25 T_A = 125°C -I_D, DRAIN CURRENT (A) -55°C 15 T_A = 85°C 10 5 0 2 2.5 0 0.5 1.5 3 3.5 -V_{GS}, GATE-SOURCE VOLTAGE (V) Fig. 2 Typical Transfer Characteristics



0.016 0.016 0.012 0.012 0.008 0.008 0.004 0.

Fig. 6 On-Resistance Variation with Temperature



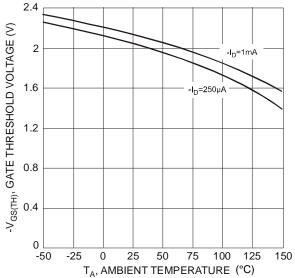
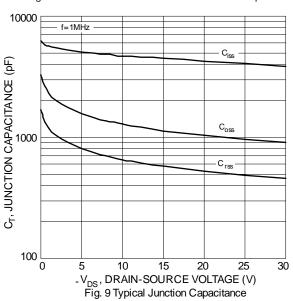
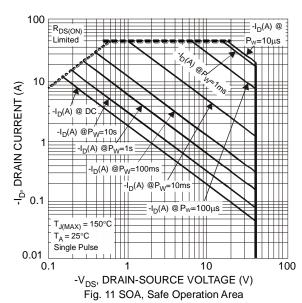
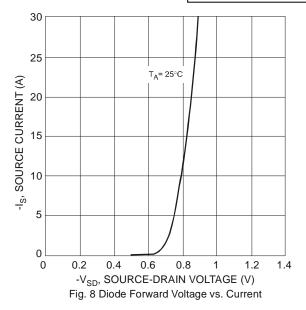
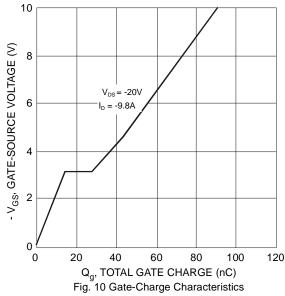


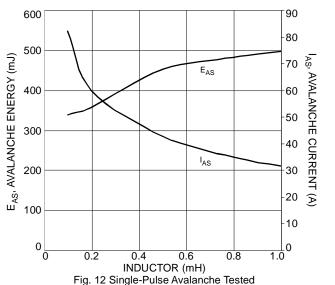
Fig. 7 Gate Threshold Variation vs. Ambient Temperature



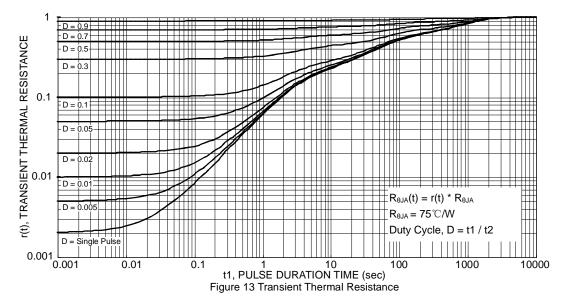










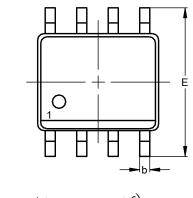


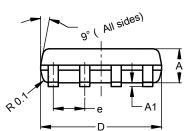


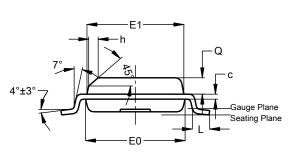
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





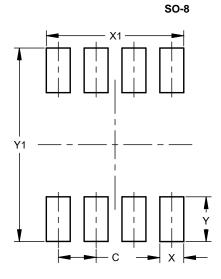




SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h			0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
V1	6.50



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